IN THE CLAIMS

Please cancel claims 1-22, 46-63, 67-76, and 83-94 without prejudice.

Please add new claims 95-119 that follow below.

Please amend claims 37 and 43-45 as follows below.

MARKED UP VERSION OF ENTIRE SET OF PENDING CLAIMS

1	1-22	. (Cancelled)

- 1 37. (Amended Once) A shielded housing formed by the method [of claim 23] comprising:
- forming a flat pattern of the shielded housing from a

 sheet of conductive material, the flat pattern including one

 or more forward fingers extending from an edge thereof;
- folding the flat pattern along fold lines to form flaps
 and sides of the shielded housing; and
- bending the flat pattern along bend lines to form the one or more forward fingers of the shielded housing.
- 1 38. (Original) A method of assembling an opto-electronic 2 module comprising:
- forming a shielded housing with an open end, the
 shielded housing formed out of a sheet of conductive
 material to provide electromagnetic radiation shielding and
 protection of components, the shielded housing including one
 or more fingers to couple the shielded housing to ground;
- assembling optical, electrical and optical-electrical components into a chassis to form a subassembly;
- inserting the subassembly into the open end of the shielded housing, the shielded housing around the subassembly; and
- 13 closing the open end of the shielded housing to hold 14 the subassembly and the shielded housing assembled together.

- 1 39. (Original) The method of claim 38 wherein,
- the shielding housing is a one-piece shielding housing
- 3 to protect components and to shield electromagnetic
- 4 radiation.
- 1 40. (Original) The method of claim 38 wherein,
- the open end is a back side and the inserting includes
- inserting a front end of the subassembly into the
- 4 open end of the back side of the shielded housing.
- 1 41. (Original) The method of claim 40 wherein,
- the closing of the open end of the back side includes
- folding a left side wing and a right side wing
- 4 into the open end, and
- folding a back side flap down over the open end to
- 6 couple to the left side wing and the right side wing.
- 1 42. (Original) The method of claim 38 wherein,
- 2 the open end is a front side and the inserting includes
- inserting a rear end of the subassembly into the open
- 4 end of the front side of the shielded housing.
- 1 43. (Amended Once) The method of claim 42 wherein,
- 2 the closing of the open end of the front side includes
- folding a strap and a septum of the shielded
- 4 housing, the strap folded across the open end to strap
- 5 the subassembly into the shielded housing, the septum
- folded into the open end to couple to the bottom side
- of the shielded housing to hold the subassembly
- 8 strapped into the shielded housing.
- 1 44. (Amended Once) The method of claim 38 wherein,
 - the forming of the shielded housing includes

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3	stamping a pattern of the shielded housing into
4	the sheet of conductive material, the pattern including
5	the one or more fingers near an edge of the flat sheet,
6	folding the sheet of conductive material along a
7	plurality of fold lines into a multi-sided
8	rectangularly shaped container but for the open end,
9	and
10	bending the one or more fingers into shape.
1	45. (Amended Once) An opto-electronic module formed by the
2	method [of claim 38] comprising:
3	forming a shielded housing with an open end, the
4	shielded housing formed out of a sheet of conductive
5	material to provide electromagnetic radiation shielding and
6	protection of components, the shielded housing including one
7	or more forward fingers extending from an edge to couple the
8	shielded housing to ground;
. 9	assembling optical, electrical and optical-electrical
10	components into a chassis to form a subassembly;
11	inserting the subassembly into the open end of the
12	shielded housing, the shielded housing around the
13	subassembly; and
14	closing the open end of the shielded housing to hold
15	the subassembly and the shielded housing assembled together.
1	46-63. (Cancelled)
1	64. (Original) A method to assemble an EMI shielding module
2	comprising:
3	forming a plurality of substantially equidistant spring
4	fingers along an edge of a flat sheet;
5	forming a strap at the edge of the flat sheet and a
6	septum on the end of the strap;
7	forming a pair of bottom flaps in the flat sheet;

folding the flat sheet along axes to form a container 8 substantially in the shape of rectangular box, the 9 rectangular box having a first end and a second end, the 10 first end having the plurality of fingers along each of a 11 plurality of edges and an opening for cable connectors, the 12 13 second end having a backside flap; folding the strap across the opening for cable 14 15 connectors; and coupling the septum to inner surfaces of the bottom 16 flaps to hold the strap across the opening. 17

- 1 65. (Original) The method of claim 64 wherein,
- the EMI shielding module is a one-piece shielded
- 3 housing to protect components and to shield electromagnetic
- 4 radiation.
- 1 66. (Original) The method of claim 64 wherein,
- the EMI shielding module encloses a module chassis
- frame, the module chassis frame being a central structural
- 4 support to which one or more optical, electrical and
- 5 optical-electrical components used in transmission and
- 6 reception of optical signals are attached.
- 1 67-76. (Cancelled)
- 1 77. (Original) A method to assemble an optical transmitter
- 2 and/or receiver, the method comprising:
- forming a plurality of fingers, a strap, and a septum
- 4 along a first edge of a conductive sheet;
- 5 placing the conductive sheet on a module chassis frame,
- the module chassis frame having a plurality of components
- 7 used in transmitting and/or receiving optical signals;
- 8 folding the conductive sheet around the module chassis
- frame such that the conductive sheet substantially encloses

- the module chassis frame but for a frontal opening adjacent to the first edge.
 - 1. 78. (Original) The method of claim 77 further comprising:
 - bending the strap and the septum around a front end of
 - 3 the module chassis frame to hold the folded conductive sheet
 - 4 and the module chassis frame together.
 - 1 79. (Original) The method of claim 77 wherein,
 - the fingers to electrically ground the folded
 - 3 conductive sheet to a ground of a host system.
 - 1 80. (Original) The method of claim 77 wherein,
 - the conductive sheet is one of metal, conductive
 - 3 plastic, and plated plastic.
 - 1 81. (Original) The method of claim 77 further comprising:
 - bending the plurality of fingers outward from the
 - 3 frontal opening.
- 1 82. (Original) The method of claim 77 further comprising:
- lifting the plurality of fingers up from an outer
- 3 surface of the conductive sheet.
- 1 83-94. (Cancelled)
- 1 95. (New) The shielded housing of claim 37 wherein,
- the shielding housing is a one-piece shielded housing
- 3 to protect components and to shield electromagnetic
- 4 radiation.
- 1 96. (New) The shielded housing of claim 37 wherein,
- 2 prior to the folding and the bending,
- placing the flat pattern onto a chassis including an

- opto-electronic device to process optical and electrical signals, and
- 6 the folding and the bending of the flat pattern is
- around the chassis to assemble the chassis and the shielded
- 8 housing together.
- 1 97. (New) The shielded housing of claim 37 wherein,
- the folding and the bending of the flat pattern
- 3 substantially forms the shielded housing but for a front
- 4 opening, and
- 5 the method further includes
- 6 performing final folding and final bending of a strap
- 7 and a septum to close the front opening.
- 1 98. (New) The shielded housing of claim 37 wherein,
- the folding and the bending of the flat pattern
- 3 substantially forms the shielded housing but for a rear
- 4 opening, and
- 5 the method further includes
- 6 performing final folding and final bending of a back
- 7 side flap to close the rear opening.
- 1 99. (New) The shielded housing of claim 37 wherein,
- 2 the flat pattern further includes a pair of tangs, a
- 3 pair of tang window openings, a strap, and a septum.
- 1 100. (New) The shielded housing of claim 37 wherein,
- the folding and the bending forms the shielded housing
- 3 including
- 4 a top side,
- a first left side flap including a left wing flap,
- a first right side flap including a right wing flap,
- 7 a second left side flap including a bottom left side
- 8 flap,

- 9 a second right side flap including a bottom right side
- 10 flap, and
- a back side flap including a retaining flap.
- 1 101. (New) The shielded housing of claim 100 wherein,
- 2 the back side flap includes a pair of tangs,
- 3 the left wing flap includes a tang window opening to
- 4 mate with one of the pairs of tangs, and
- 5 the right wing flap includes a tang window opening to
- 6 mate with one of the pairs of tangs.
- 1 102. (New) The shielded housing of claim 101 wherein,
- a strap extends from a front edge of the top side at
- one end,
- and a septum extends at an opposite end of the strap.
- 1 103. (New) The shielded housing of claim 100 wherein,
- the one or more forward fingers extend from a front
- 3 edge of the top side, the second left side flap, the second
- 4 right side flap, the bottom left side flap, and the bottom
- 5 right side flap.
- 1 104. (New) The shielded housing of claim 37 wherein,
- the one or more forward fingers to couple to a host
- 3 panel to ground the shielded housing and to seal around an
- 4 opening in the host panel to avoid electromagnetic radiation
- 5 leaking out therefrom.
- 1 105. (New) The shielded housing of claim 37 wherein,
- the flat pattern is formed by etching the sheet of
- 3 conductive material.
- 1 106. (New) The shielded housing of claim 37 wherein,
- the flat pattern is by formed stamping the sheet of

- 3 conductive material.
- 1 107. (New) The shielded housing of claim 37 wherein,
- the flat pattern is formed by cutting the sheet of
- 3 conductive material.
- 1 108. (New) The opto-electronic module of claim 45 wherein,
- the shielding housing is a one-piece shielding housing
- 3 to protect components and to shield electromagnetic
- 4 radiation.
- 1 109. (New) The opto-electronic module of claim 45 wherein,
- the open end is a back side and the inserting includes
- inserting a front end of the subassembly into the
- 4 open end of the back side of the shielded housing.
- 1 110. (New) The opto-electronic module of claim 109 wherein,
- the closing of the open end of the back side includes
- folding a left side wing and a right side wing
- 4 into the open end, and
- folding a back side flap down over the open end to
- 6 couple to the left side wing and the right side wing.
- 1 111. (New) The opto-electronic module of claim 45 wherein,
- the open end is a front side and the inserting includes
- inserting a rear end of the subassembly into the open
- 4 end of the front side of the shielded housing.
- 1 112. (New) The opto-electronic module of claim 111 wherein,
- the closing of the open end of the front side includes
- folding a strap and a septum of the shielded
- 4 housing, the strap folded across the open end to strap
- 5 the subassembly into the shielded housing, the septum
- folded into the open end to couple to the bottom side

of the shielded housing to hold the subassembly 7 8 strapped into the shielded housing. 113. (New) 1 The opto-electronic module of claim 45 wherein, 2 the forming of the shielded housing includes stamping a pattern of the shielded housing into 3 the sheet of conductive material, the pattern including 4 the one or more forward fingers extending from the edge 5 of the sheet. 6 folding the sheet of conductive material along a 7 plurality of fold lines into a multi-sided 8 9 rectangularly shaped container but for the open end, and 10 bending the one or more forward fingers into 11 12 shape. An optical transmitter and/or receiver formed by 1 the method comprising: 2 forming a plurality of fingers, a strap, and a septum 3 along a first edge of a conductive sheet; 4 placing the conductive sheet on a module chassis frame, 5 the module chassis frame having a plurality of components 6 used in transmitting and/or receiving optical signals;

folding the conductive sheet around the module chassis frame such that the conductive sheet substantially encloses the module chassis frame but for a frontal opening adjacent to the first edge.

- 1 115. (New) The optical transmitter and/or receiver of claim 2 114 formed by the method further comprising:
- bending the strap and the septum around a front end of the module chassis frame to hold the folded conductive sheet and the module chassis frame together.

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- 1 116. (New) The optical transmitter and/or receiver of claim
- 2 114 wherein,
- 3 the fingers to electrically ground the folded
- 4 conductive sheet to a ground of a host system and to seal an
- opening in a host panel of the host system to avoid
- 6 electromagnetic radiation leaking out through the opening in
- 7 the host panel.
- 1 117. (New) The optical transmitter and/or receiver of claim
- 2 114 wherein,
- 3 the conductive sheet is one of metal, conductive
- 4 plastic, and plated plastic.
- 1 118. (New) The optical transmitter and/or receiver of claim
- 2 114 formed by the method further comprising:
- bending the plurality of fingers outward from the
- 4 frontal opening to form a plurality of forward fingers
- 5 extending out therefrom.
- 1 119. (New) The optical transmitter and/or receiver of claim
- 2 114 formed by the method further comprising:
- 3 lifting the plurality of fingers up from an outer
- 4 surface of the conductive sheet to form a plurality of
- 5 backward fingers.